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PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM 10064500	FILING DATE 07/22/2002	CLASS 219	SUBCLASS 678 000	GAU 3742	EXAMINER Van
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William; 676 000

**CONTINUING DATA VERIFIED:
*By Name*** FOREIGN APPLICATIONS VERIFIED:
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PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed 35 USC 119 conditions met Verified and Acknowledged Examiners's initials <i>ext</i>		ATTORNEY DOCKET NO 06618/891001 / CIT 2969 C
TITLE : Microwave bonding of thin film metal coated substrates U.S. DEPT. OF COMM/PAT. & TM-PTO-436L(Rev. 12-94)		

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED			
		<table border="1"> <tr> <td>Total Claims</td> <td>Print Claim for O.G</td> </tr> </table>		Total Claims	Print Claim for O.G
Total Claims	Print Claim for O.G				
		DRAWING			
		Sheets Drwg.	Figs.Drwg.		
		Print Fig.			
ISSUE FEE					
Amount Due	Date Paid				
TERMINAL DISCLAIMER		Primary Examiner			
		Application Examiner			
PREPARED FOR ISSUE					
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